

1-338088-6 Product Details



Documentation & Additional Information			
Product Drawings: • INVERTIBLE MODULAR JACK, 8 POSITION SURFACE MOUNT AP (PDF, English)	Additional Information: • Product Line Information		
Catalog Pages/Data Sheets: None Available 	Related Products: • Tooling		
Product Specifications: • None Available			
Application Specifications: None Available 			
Instruction Sheets: None Available 			
CAD Files: (CAD Format & Compression Information) • 2D Drawing (DXF, Version W)			
• 3D Model (IGES, Version W)			
3D Model (STEP, Version W)			

Product Features (Please use the Product Drawing for all design activity)

Product Type Features:

- Product Type = Connector
- Jack Type = RJ45
- PCB Mounting Orientation = Top Entry (Vertical)
- PCB Mount Style = Surface Mount
- Termination Method to PC Board = Solder
- Performance Category = Cat 3
- LED = Without
- Grounding Options = Without
- Panel Stops = Without
- Keved = No
- Profile = Standard
- Color = Black
- Latch Style = Standard

Mechanical Attachment:

- Panel Mount Retention = With
- Flanged = No

Electrical Characteristics: Shielded = No

Termination Features:

Solder Tail Contact Plating = Tin over Nickel

Dimensions:

- Height (mm [in]) = 12.70 [0.500]
- PCB Thickness, Recommended (mm [in]) = 1.57 [0.062]

Body Features:

- Inverted Jack Face = No
- Solder Bracket Material = Tin Plated Brass

Contact Features:

- Contact Plating, Mating Area, Material = Conforms to Product Requirements based on Product Specification 108-19117, Gold or Gold Flash over Palladium Nickel
- Contact Base Material = Phosphor Bronze

Housing Features:

- Housing Material = High Temperature Nylon
- UL Flammability Rating = UL 94V-0

Configuration Features:

- Preloaded = Yes
- Port Configuration = Single
- Jack Configuration = 1 x 1
- Number of Positions = 8
- Number of Contacts Loaded = 8

Industry Standards:

- RoHS/ELV Compliance = RoHS compliant, ELV compliant
- Lead Free Solder Processes = Reflow solder capable to 245°C, Reflow solder capable to 260°C
- RoHS/ELV Compliance History = Converted to comply with RoHS directive

Packaging Features:

- Packaging Method = Tape Mounted on Reel
 - Packaging Quantity = 250 Pieces (per 36 cm diameter reel)

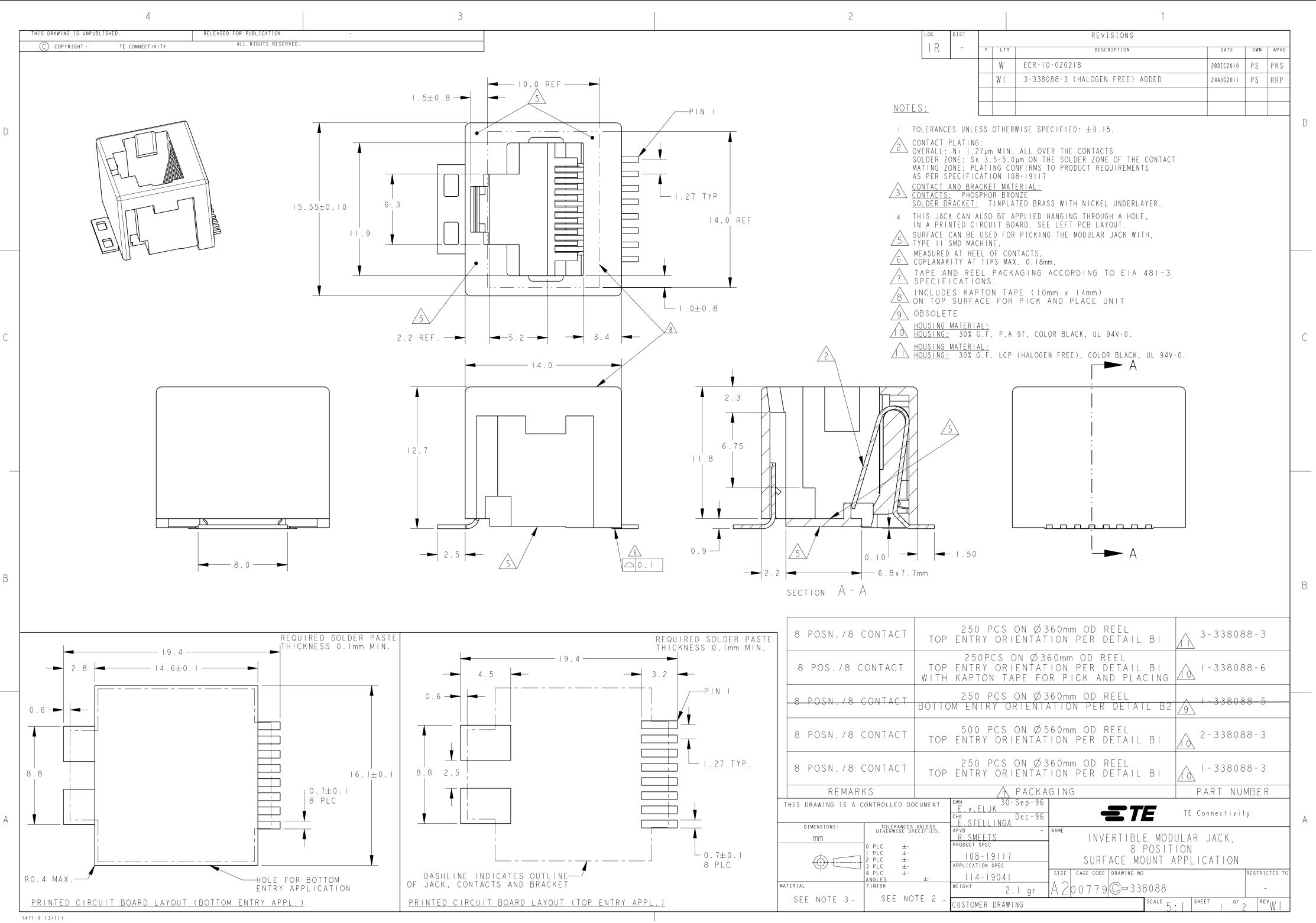
Product Availability:

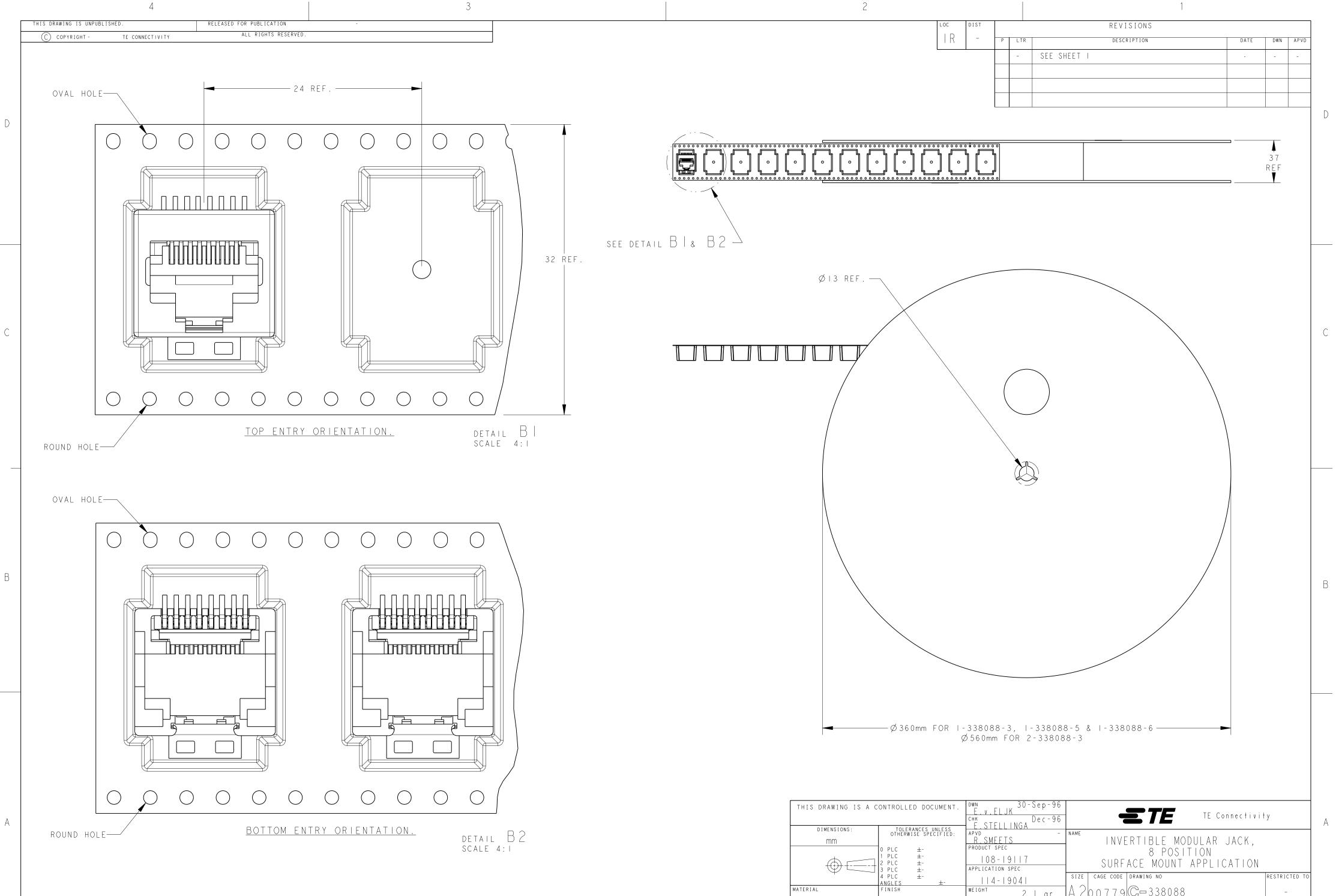
Region = Asia, North America

Other:

- Brand = AMP
- Comment = Kapton tape applied to top surface of jack to facilitate vacuum pickup.; Surface can be used for application by Type II SMD Machine.; This Invertible Modular Jack can also be applied bapping through a hole in the PC Board (See PCB)

Layout); Surface can be used for application by Type I and Type II SMD machines.; Embossed tape according to EIA 481-3.





	ONTROLLED DOCUMENT.	Dwn 30-Sep-96 Е.v.ELJK Снк Dec-96	TE Connectivity
DIMENSIONS: MM	TOLERANCES UNLESS OTHERWISE SPECIFIED:	APVD - R SMEETS	NAME INVERTIBLE MODULAR JACK,
	0 PLC ±- 1 PLC ±- 2 PLC ±- 3 PLC ±-	PRODUCT SPEC 08-19117 APPLICATION SPEC	8 POSITION SURFACE MOUNT APPLICATION
\downarrow \square	4 PLC ±- ANGLES ±-	4 - 904	SIZE CAGE CODE DRAWING NO RESTRICTED TO
MATERIAL	FINISH	weight 2.lgr	A 200779 C = 338088 - 1
-	-	CUSTOMER DRAWING	SCALE 5: SHEET 2 OF 2 REVW